

10/531553

13 APR 2005

0321.68367

PATENT

#4/A

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Vitali Nesterenko

I hereby certify that this paper is being deposited with the United States Postal Service as EXPRESS MAIL in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this date.

Serial No.:

4/13/2005

Date

Express Mail Label No.: EL965134964US

Filed: April 13, 2005

For: ISOSTATIC PRESSURE ASSISTED
WAFER BONDING METHOD

Group Art Unit:

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Washington, D.C. 20231

Dear Sir:

Prior to examination of this application, please amend the application as follows: